H11DSi



Key Features

- 1. Dual AMD EPYC™ 7001/7002* Series Processors (*AMD EPYC 7002 series drop-in support requires board revision 2.x)
- 2. 2TB Registered ECC DDR4 2666MHz SDRAM in 16 DIMMs 4TB Registered ECC DDR4 3200MHz SDRAM in 16 DIMMs (Board revision 2.x required)
- 3. Expansion slots: 2 PCI-E 3.0 x16 3 PCI-E 3.0 x8

M.2 Interface: 1 SATA/PCI-E 3.0 x2 (Platform with EPYC 7002 processor only supports PCI-E type M.2 module)

M.2 Form Factor: 2280, 22110

M.2 Key: M-key

- 4. 10 SATA3, 1 M.2, 2 SATA DOM
- 5. Dual Gigabit Ethernet LAN Ports
- 6. ASPEED AST2500 BMC graphics
- 7. Up to 2 USB 3.0 ports Up to 4 USB 2.0 ports
- 8. 8 4-pin PWM Fan & Speed control

Note: Image above may show a varied configuration of optional parts. Please refer to parts list for standard parts included.

Links & Resources

- Tested Memory List
- ▶ Tested HDD List
- Tested AOC List
- Motherboard Manual
- Update Your BIOS
- ▶ IPMI Firmware
- Download the Latest Drivers and Utilities
- Download Driver CD
- OS Compatibility



Specifications

Product SKUs		Chassis (Optimize	ed for H11DSi)
MBD-H11DSi	■ H11DSi	2 U	■ SC213AC-R1K23LPB
MBD-H11DSi-B	■ H11DSi (Bulk Pack)		• SC216BE1C4-R1K23LPB
Physical Stats			 SC825TQC-R802LPB SC826BE1C4-R1K23LPB SC829HE1C4-R1K62LPB
Form Factor	■ E-ATX	3U	■ <u>SC836BE1C-R1K23B</u>
Dimensions	■ 12" x 13.05" (30.5cm x 33.1cm)	4U	■ <u>SC745BAC-R1K28B2</u>
Processor/Chipset			■ <u>SC846BE1C-R1K23B</u>
CPU	■ Dual AMD EPYC™ 7001/7002*	System BIOS	
	series Processors (*Board revision 2.x required)	BIOS Type	AMI 128Mb SPI Flash EEPROM
	Socket SP3	BIOS Features	■ Plug and Play (PnP)
	■ Up to 240W TDP		■ DMI 2.3 ■ PCI 2.2
Cores	Up to 32 CoresUp to 64 Cores (Board revision 2.x		■ ACPI 5.1
	required)		USB Keyboard SupportSMBIOS 3.1.1
Chipset	■ System on Chip	Management	
System Memory		Software	■ Super Doctor 5
Memory	■ 16 DIMM sockets	Contware	• Watch Dog
Capacity	■ Supports up to 2TB Registered ECC		■ NMI ■ SUM
	DDR4 2666MHz SDRAM in 16 DIMMs		IPMI 2.0, KVM with dedicated LAN
	 Supports up to 4TB Registered ECC DDR4 3200MHz SDRAM (Board 	Power	■ ACPI Power Management
	revision 2.x required)	Configurations	 Power-on mode control for AC power loss recovery
	8-channel memory bus	PC Health Monitor	·
Memory Type	DDR4 2666 MHz Registered ECC, 288-pin gold-plated DIMMs		
	■ DDR4 3200 MHz Registered ECC,	CPU	Monitors CPU Core Voltages, +1.5V, +1.8V, +12V +5V, +5V standby
	288-pin gold-plated DIMMs (Board revision 2.x required)		 CPU switching voltage regulator
DIMM Sizes	■ 8GB, 16GB, 32GB, 64GB, 128GB,		Supports system management utilityVBAT
	256GB* (*Board revision 2.x	FAN	■ Up to 8-fan status tachometer
Momory Voltago	required) 1.2V		monitoring Up to eight 4-pin fan headers
Memory Voltage Error Detection			■ Dual Cooling Zone
Error Detection	Corrects single-bit errorsDetects double-bit errors (using ECC		Status monitor for speed controlPulse Width Modulated (PWM) fan
	memory)		connectors
On-Board Devices		Temperature	 Monitoring for CPU and chassis
SATA	SATA3 (6 Gbps)		environment CPU Thermal Trip Support
IPMI	 Support for Intelligent Platform 		■ Thermal control for 8x Fan
	Management Interface v.2.0 ■ IPMI 2.0 with virtual media over LAN and KVM-over-LAN support		connectors I ² C Temperature Sensing Logic
		LED	■ CPU / System Overheat LED
	■ ASPEED AST2500 BMC	Other Features	■ Chassis Intrusion Detection
Network Controllers	2 1GbE LAN via Intel® i350-AM211 Realtek RTL8211E PHY (dedicated		Chassis Intrusion HeaderUID
	IPMI)	On another Freedom	
VGA	■ ASPEED AST2500 BMC		ment / Compliance
Input / Output		Environmental Specifications	 Operating Temperature: 10°C to 35°C (50°F to 95°F)
SATA	■ 10 SATA3 (6 Gbps) ports	·	■ Non-operating Temperature:
LAN	 2 RJ45 Gigabit Ethernet LAN ports 1 RJ45 Dedicated IPMI LAN port 		-40°C to 70°C (-40°F to 158°F) ■ Operating Relative Humidity: 8% to 90% (non-condensing)
USB	2 USB 3.0 ports (rear)4 USB 2.0 ports (2 rear + 2 via header)		 Non-operating Relative Humidity: 5% to 95% (non-condensing)
VGA	■ 1 VGA port		
.00	- Tortport		

Others	1 COM port (rear)2 SATA DOM power connector1 TPM 2.0 header	
Expansion Slots		
PCI-Express	■ 3 PCI-E 3.0 x8 ■ 2 PCI-E 3.0 x16	
М.2	 Interface: 1 SATA/PCI-E 3.0 x2 (Platform with EPYC 7002 processor only supports PCI-E type M.2 module) Form factor: 2280, 22110 Key: M-key 	

Parts List

Bulk Pack List

	Part Number	Qty	Description
H11DSI	MBD-H11DSI-B	1	H11DSI Motherboard
I/O Cable	CBL-0044L	2	57.5CM SATA FLAT S-S PBF
I/O Shield	MCP-260-00042-0N	1	STD I/O SHIELD FOR X9 SOCKET R SERVER MB

Optional Parts List

	Part Number	Qty	Description
I/O Cable	CBL-0097L-03	2	Ipass to 4 SATA, 51cm, W/51cm SB, S, 30AWG
TPM security module	<u>AOM-TPM-9655V</u>	-	TPM 1.2 module with Infineon 9655, RoHS/REACH,PBF;
	<u>AOM-TPM-9665V</u>	-	TPM 2.0 module with Infineon 9665, RoHS/REACH,PBF;